

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Yeshik Shin et al.
Application No. : 10/035,911 Confirmation No.: 2160
Filed : November 7, 2001
For : METHOD AND SYSTEM FOR NESTING OF
COMMUNICATIONS PACKETS

Docket No. : 371798019US

Date : May 24, 2002

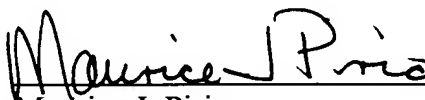
Commissioner for Patents
Washington, DC 20231

AUTHORIZATION FOR EXTENSIONS OF TIME UNDER 37 C.F.R. § 1.136(A)(3)

Sir:

With respect to the above-identified application, the Commissioner is authorized to treat any concurrent or future reply requiring a petition for an extension of time under 37 C.F.R. § 1.136(a)(3) for its timely submission as incorporating a petition therefor for the appropriate length of time. The Commissioner is also authorized to charge any fees which may be required, or credit any overpayment, to Deposit Account No. 50-0665.

Date May 24, 2002

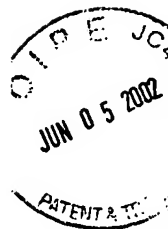


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I hereby certify that on the date specified below, this correspondence is being deposited with the United States Postal Service as first-class mail in an envelope addressed to the Commissioner for Patents, Washington, DC 20231.

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5/24/02

Jeanne Connelly

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TRANSMITTAL OF FORMAL DRAWINGS

Sir:

Enclosed please find 59 sheets of formal drawings (Figures 1-49B) for the above-identified application.

Respectfully submitted,
Perkins Coie LLP

Maurice J. Pirio

Registration No. 33,273

MJP:jc

Enclosures:

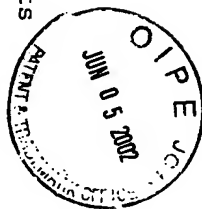
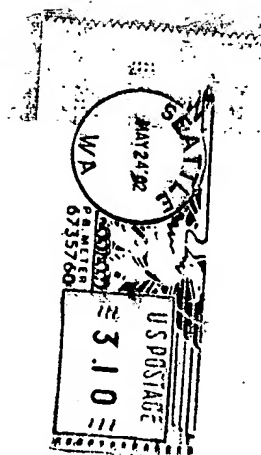
59 Sheets of Drawings

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